



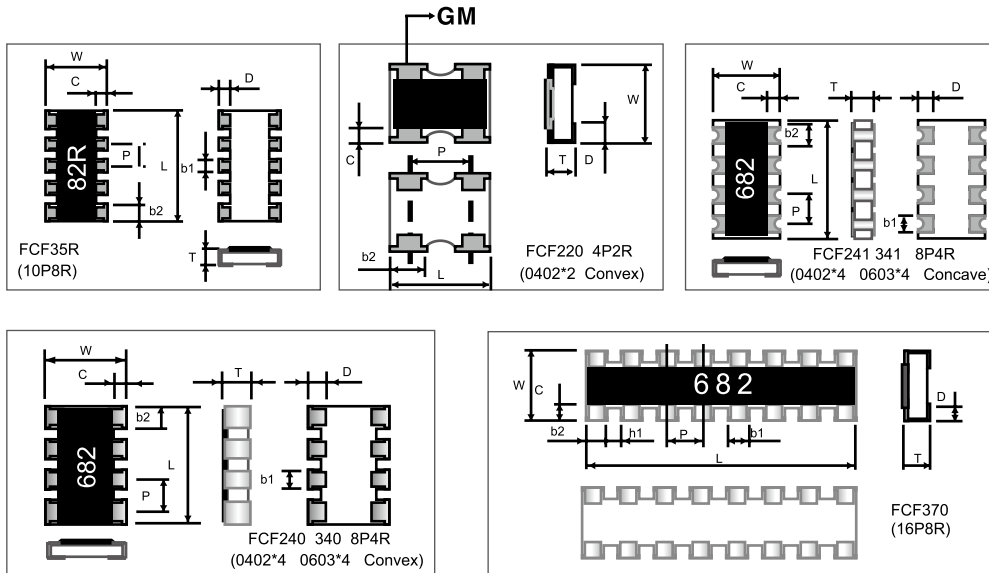
FEATURES

High density packaging provides higher productivity.
 Stable convex terminal reduces assembly costs.
 Compatible with flow and reflow soldering.

APPLICATIONS

- Computer
- Portable audio
- Mobile phone
- Battery charger
- Camcorder
- Hard Disk Driver

CONFIGURATION

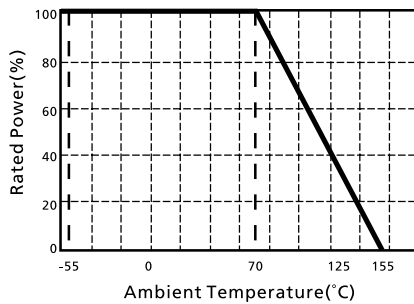


DIMENSIONS

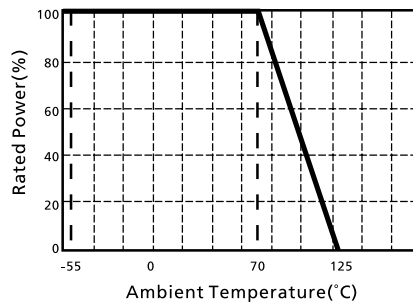
TYPE	L	W	T	C	D	P	b1	b2	h1
FCF220	1.00±0.10	1.00±0.10	0.35±0.10	0.20±0.15	0.25±0.17	0.65±0.10	-	0.34±0.10	-
FCF240	2.00±0.10	1.00±0.10	0.45±0.10	0.20±0.10	0.25±0.10	0.50±0.05	0.30±0.05	0.40±0.10	-
FCF241	2.00±0.10	1.00±0.10	0.45±0.10	0.20±0.15	0.25±0.10	0.50±0.05	0.25±0.05	0.25±0.05	-
FCF340	3.20±0.20	1.60±0.10	0.50±0.10	0.30±0.20	0.30±0.20	0.80±0.10	0.45±0.10	0.60±0.15	-
FCF341	3.20±0.20/-0.10	1.60±0.20/-0.10	0.60±0.10	0.35±0.15	0.50±0.15	0.80±0.10	0.50±0.15	0.60±0.15	-
FCF35R	3.30±0.20	1.60±0.15	0.55±0.10	0.40±0.15	0.40±0.15	0.64±0.05	0.40±0.15	0.50±0.05	-
FCF370	4.00±0.20	1.60±0.15	0.45±0.10	0.30±0.20	0.30±0.20	0.50±0.20	0.30±0.10	0.40±0.20	0.20±0.10

(unit: mm)

POWER DERATING CURVE

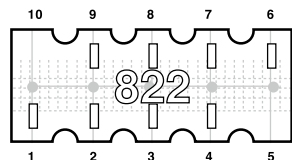


Maximum dissipation in percentage of rated power as a function of the ambient temperature for FCF220 , FCF240 , FCF241 , FCF340 , FCF341 , FCF35R

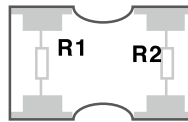


Maximum dissipation in percentage of rated power as a function of the ambient temperature for FCF370

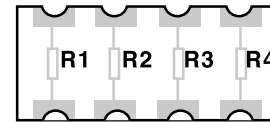
CIRCUIT



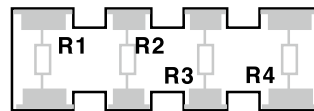
FCF35R



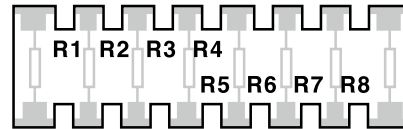
FCF220



FCF241 / 341



FCF240 / 340



R1=R2=R3=R4=R5=R6=R7=R8

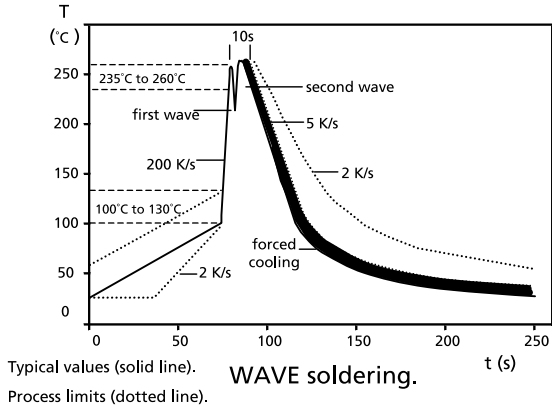
FCF370

RATING

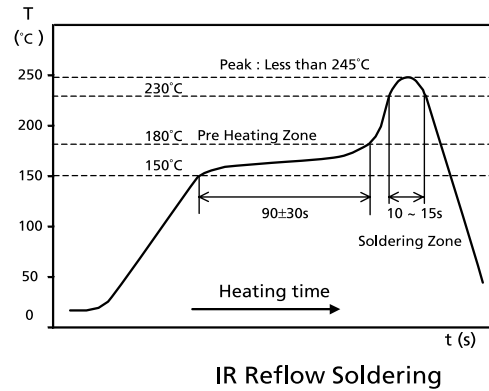
Type	Size	Termination Construction	Power Rating at 70 °C	Max. RCWV	Max. Overload Voltage	Resistance Tolerance (%)	Temperature Coefficient (TCR; ppm/°C)	Resistance Range(Ω)		Standard Resistance Values
								Min.	Max.	
FCF220	4P2R 0402*2	Convex	1/16W	25V	50V	±5% (J)	±300	0Ω, 10Ω	1MΩ	E-24
FCF240	8P4R 0402*4	Convex	1/16W	25V	50V	±5% (J) ±1% (F)	±300	0Ω, 10Ω 100Ω	1MΩ 1MΩ	E-24
FCF241	8P4R 0402*4	Concave	1/16W	25V	50V	±5% (J) ±1% (F)	±300	0Ω, 10Ω 10Ω	1MΩ 1MΩ	E-24
FCF340	8P4R 0603*4	Convex	1/16W	50V	100V	±5% (J) ±1% (F)	±200	0Ω, 10Ω	1MΩ	E-24
FCF341	8P4R 0603*4	Concave	1/16W	50V	100V	±5% (J)	±200	0Ω, 10Ω	1MΩ	E-24
FCF35R	10P8R	Convex	1/16W	25V	50V	±5% (J)	±200	10Ω	100KΩ	E-24
FCF370	16P8R	Convex	1/16W	25V	50V	±5% (J) ±1% (F)	±200	0Ω, 10Ω 10Ω	100KΩ 100KΩ	E-24

Jumper : All networks (except FCF35R) maximum resistance $R_{max} < 50m\Omega$ and rated current $I_R \leq 1A$

SOLDERING TEMPERATURE CURVE



WAVE soldering.



IR Reflow Soldering

PART NUMBER

FCF Type	340 Size	J Tolerance	T Packing	473 Marking
FCF	220 : 0402*2 240 : 0402*4(Convex) 241 : 0402*4(Concave) 340 : 0603*4(Convex) 341 : 0603*4(Concave) 35R : 10P8R 370 : 16P8R	F : ± 1% J : ± 5%	T : Paper tape - 5Kpcs V : Paper tape - 10Kpcs W : Paper tape - 20Kpcs	examples: 473 47x10 ³ =47KΩ

RESISTANCE MARKING

E - 24 SERIES



3 digit marking for E24

examples : 473 47x10³ = 47KΩ

105 10x10⁵ = 1MΩ

100 = 10 Ω

STANDARE RESISTANCE VALUE

E3	10				22				47								
E6	10		15		22		33		47		68						
E12	10	12	15	18	22	27	33	39	47	56	68	82					
E24	10	11	12	13	15	16	18	20	22	24	27	30	33	36	39	43	47
	51	56	62	68	75	82	91										

SPECIFICATION AND TEST METHODS

ITEM	SPECIFICATION	TEST METHOD
DC Resistance	J: $\pm 5\%$, F: $\pm 1\%$ Zero ohm Jumper < 50m Ω	IEC 60115-1 / JIS C 5201-1 , Clause 4.5 Measure the resistance value.
Short time Overload	J: $\Delta R \leq \pm (2\% + 0.1\Omega)$ F: $\Delta R \leq \pm (1\% + 0.05\Omega)$	IEC 60115-1 / JIS C 5201-1 , Clause 4.13 2.5X Rated voltage or Max. Overload Voltage for 5 sec. measure resistance after 30 minutes
Solderability	Over 95% of termination must be covered with solder	IEC 60115-1 / JIS C 5201-1 , Clause 4.17 After immersing flux, dip in the 235 $\pm 2^\circ\text{C}$ molten solder bath for 2 ± 0.5 sec.
Resistance to Solder Heat	J: $\Delta R \leq \pm (1\% + 0.1\Omega)$ F: $\Delta R \leq \pm (0.5\% + 0.05\Omega)$ No mechanical damage	IEC 60115-1/JIS C 5201-1 , Clause 4.18 With 260 $\pm 5^\circ\text{C}$ for 10 ± 1 sec.
Temperature Coefficient of Resistance (TCR)	Size: 0402*2,0402*4 ± 300 ppm/ $^\circ\text{C}$ Size: 0603*4,10P8R,16P8R ± 200 ppm/ $^\circ\text{C}$	IEC 60115-1 / JIS C 5201-1 , Clause 4.8 Test temperature : 25 $^\circ\text{C}$ (T1) \rightarrow -55 $^\circ\text{C}$ (T2) 25 $^\circ\text{C}$ (T1) \rightarrow +155 $^\circ\text{C}$ (T2) TCR (ppm/ $^\circ\text{C}$) = $\frac{R2-R1}{R1} \times \frac{1}{T2-T1} \times 10^6$ T1: 25 $^\circ\text{C}$ T2: Test temperature R1: Resistance at reference temperature (T1) R2: Resistance at test temperature (T2)
Load Life Humidity	J: $\Delta R \leq \pm (3\% + 0.1\Omega)$ F: $\Delta R \leq \pm (1\% + 0.05\Omega)$	IEC 60115-1 / JIS C 5201-1 , Clause 4.24 Maintain the temperature of the resistor at 40 $\pm 2^\circ\text{C}$ and 90~95% R.H. with the rated voltage applied. Cycle ON for 1.5 hours and OFF for 0.5 hour for 1000+48/-0 hours. After 1~4 hour, measure the resistance value.
Load Life	J: $\Delta R \leq \pm (3\% + 0.1\Omega)$ F: $\Delta R \leq \pm (1\% + 0.05\Omega)$	IEC 60115-1 / JIS C 5201-1 , Clause 4.25 Permanent resistance change after 1000+48/-0 hours (1.5 hours ON , 0.5 hour OFF) at RCWV or Max. Keep the resistor at 70 $\pm 2^\circ\text{C}$ ambient
Temperature Cycle	J: $\Delta R \leq \pm (1\% + 0.1\Omega)$ F: $\Delta R \leq \pm (0.5\% + 0.05\Omega)$ No mechanical damage	IEC 60115-1 / JIS C 5201-1 , Clause 4.19 Repeat 5 cycles as follows -55 $^\circ\text{C}$ (30 min.) ~ +25 $^\circ\text{C}$ (2~3 min.) +125 $^\circ\text{C}$ (30 min.) ~ +25 $^\circ\text{C}$ (2~3 min.) for FC370 -55 $^\circ\text{C}$ (30 min.) ~ +25 $^\circ\text{C}$ (2~3 min.) +155 $^\circ\text{C}$ (30 min.) ~ +25 $^\circ\text{C}$ (2~3 min.) for FCF220,FCF240,FCF241,FCF340,FCF341,FCF35R
Insulation Resistance	Between termination and coating must be over 1000M Ω	IEC 60115-1 / JIS C 5201-1 , Clause 4.6 Test voltage: 100 ± 15 V
Bending Strength	J: $\Delta R \leq \pm (1\% + 0.1\Omega)$ F: $\Delta R \leq \pm (0.5\% + 0.05\Omega)$ No mechanical damage	IEC 60115-1 / JIS C 5201-1 , Clause 4.33 Resistance change after bended on the 90mm PCB. Bend: 1mm for FCF370 2mm for FCF220,FCF240,FCF241, FCF340, FCF341,FCF35R